TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

T 6 B 7 9

COLUMN AND ROW DRIVER LSI FOR A DOT MATRIX GRAPHIC LCD

The TOSHIBA T6B79 is a driver for a small-or mediumscale dot matrix graphic LCD. It includes the functions of the TOSHIBA T9841B (column driver) and the TOSHIBA T9842B (row driver). It has an 8-bit interface circuit and can be operated with an 80-Series MPU. It generates all the timing signals for the display with an on-chip oscillator. It receives 8-bit data from an MPU, latches the data to an on-chip RAM, and displays the image on the LCD (the data in the display RAM correspond to the dots on the display). The device has 64 column driver outputs and 48 row driver outputs enabling it to drive a 64-dot by 48-dot LCD. In addition, there are resistors to divide the bias voltage, a power supply op-amp, DC-DC converter (doubler, tripler and quadruplexer) and contrast control circuit enabling the LCD to be driven by a single power supply.

| | ι | Jnit: mm | _ | | | | |
|---|------------|----------|---|--|--|--|--|
| T6B79 | LEAD PITCH | | | | | | |
| 10679 | IN | OUT | | | | | |
| (UA) | 0.8 | 0.28 | | | | | |
| Please contact Toshiba or an authorized Toshiba dealer for information on package dimensions. | | | | | | | |
| TCP (Tape Car | rier Pack | age) | | | | | |

FEATURES

- On-chip display RAM capacity: $64 \times 48 = 3072$ bits
- Display RAM data
 - ① Display data = 1 LCD turns on.② Display data = 0 LCD turns off.
- 1/16, 1/32 or 1/48 selectable duty cycle
- Word length of display data can be switched between eight bits and six bits according to the character font.
- LCD driver outputs: 64 column driver outputs and 48 row driver outputs
- Interface with 80-Series MPU
- On-chip oscillator with one external resistor
- Low power consumption
- On-chip resistors to divide bias voltage, on-chip operational amplifier for LCD supply, on-chip DC-DC converter (doubler, tripler and quadruplexer), on-chip contrast control circuit
- CMOS process
- Operating voltage: 2.7V to 5.5V
- Operating voltage for LCD drive signal

 $V_{DD} - V_{EE} = 16.0V \text{ (max)}$

Package: TCP (Tape Carrier Package)

970917EBE2

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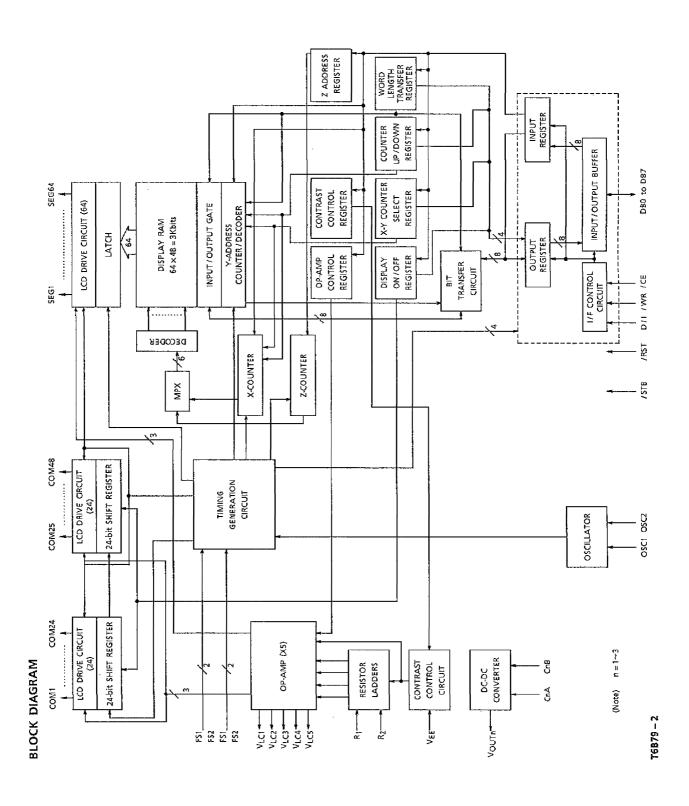
 Polyimide base film is hard and thin. Be careful not to injure yourself on the film or to scratch any other parts with the film. Try to design and manufacture products so that there is no chance of users touching the film after assembly, or if they do , that there is no chance of them injuring themselves. When cutting out the film, try to ensure that the film shavings do not cause accidents. After use, treat the leftover film and reel spacers as industrial waste.

 Light striking a semiconductor device generates electromotive force due to photoelectric effects. In some cases this can cause the device to

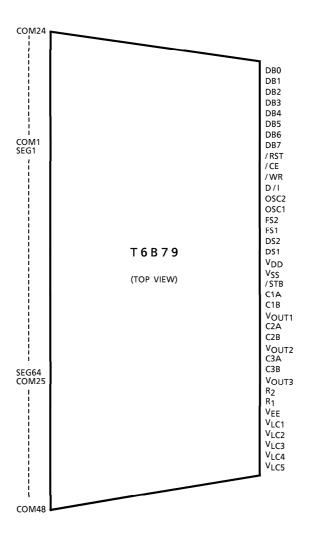
- Light striking a semiconductor device generates electromotive force due to photoelectric effects. In some cases this can cause the device to malfunction.

 This is especially true for devices in which the surface (back), or side of the chip is exposed. When designing circuits, make sure that devices are protected against incident light from external sources. Exposure to light both during regular operation and during inspection must be taken into
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 The information contained herein is subject to change without notice.



PIN ASSIGNMENT



(*) The above diagram shows the pin configuration of the LSI chip; it does not show the configuration of the tape carrier package.

PIN FUNCTIONS

| FIN TONCHONS | | | | | | | | | | |
|---------------------------------|--------|---|---|--|---|--|--|--|--|--|
| PIN NAME | 1/0 | F | UNCTIONS | | | | | | | |
| SEG1 to SEG64 | Output | Column driver output | | | | | | | | |
| COM1 to COM48 | Output | Row driver output | | | | | | | | |
| DB0 to DB7 | 1/0 | Data bus | | | | | | | | |
| D/I | Input | Input for data/instruction select s D/I=H indicates that the data D/I=L indicates that the data | on DB0 to DB7 | | | | | | | |
| /WR | Input | Input for write select signal ✓ /WR = H → Read selected ✓ /WR = L → Write selected | | | | | | | | |
| / CE | Input | Input for chip enable signal | | | | | | | | |
| / RST | Input | Input for reset signal • /RST = L→Reset state | | | | | | | | |
| / STB | Input | Input for standby signal Usually connected to VDD ✓ STB = L → T6B79 is in standby or data. Column driver signal | | | | | | | | |
| FS1, FS2 | Input | Inputs for frequency selection | FS2 FS1 f ₀ 0 0 0 1 1 0 1 1 | OSC (kHz 26.88 53.76 215.00 430.10 | f _{COM} (Hz) 35 35 35 35 35 35 | | | | | |
| DS1, DS2 | Input | Inputs for duty selection | | DS2 0 0 1 1 1 | DS1 DUTY 0 1/16 1 1/32 0 1/48 1 1/48 | | | | | |
| OSC1, OSC2 | _ | When using the internal clock oscillator, connect a resistor between OSC1 and OSC2. When using an external clock, connect the clock as input to OSC1 and leave OSC2 open. | | | | | | | | |
| R ₁ , R ₂ | _ | Inputs for LCD drive bias selection LCD drive bias selection is shown following table. | | R ₂ 0 0 1 1 | R ₁ Bias 0 1/5 1 1/6 0 1/7 1 1/8 | | | | | |

| PIN NAME | 1/0 | FUNCTIONS | | | | | |
|---|-----|---|--|--|--|--|--|
| C1A, C1B | _ | Connect using a capacitor for ×2 DC-DC converter. | | | | | |
| V _{OUT1} | _ | DC-DC converter output (x2 output) | | | | | |
| C2A, C2B | _ | Connect using a capacitor for ×3 DC-DC converter. | | | | | |
| V _{OUT2} | _ | DC-DC converter output (×3 output) | | | | | |
| C3A, C3B | | | | | | | |
| V _{OUT3} | _ | DC-DC converter output (x4 output) | | | | | |
| Vee | | Power supply for LCD driver circuit | | | | | |
| V _{EE} — When using on-chip DC-DC converter, connect V _{EE} to V _{OUT} . | | | | | | | |
| V _{LC1} to V _{LC5} — Power supply for LCD driver circuit | | | | | | | |
| V _{DD} , V _{SS} — Power supply for logic circuit. Reference : Ground | | | | | | | |

FUNCTION OF EACH BLOCK

Interface logic

The T6B79 can be operated with an 80-Series MPU. Fig. 1 shows an example of the interface.



Input register

This register stores 8-bit data from the MPU. The D/I signal distinguishes between command data and display data.

Output register

This register stores 8-bit data from the display RAM. When display data is read, the display data specified by the address in the address counter is stored in this register. After that, the address is automatically incremented or decremented. Therefore, when an address is set, the correct data does not appear as the first data item that is read. The data in the specified address location appears as the second data item that is read.

X-address counter

The X-address counter is a 48-up/down counter. It holds the row address of a location in the display RAM. Writing data to or reading data from the of display RAM causes the X-address to be automatically incremented or decremented.

Y- (page) address counter

The Y- (page) address counter is either an 8-up/down counter, when the word length is eight bits, or an 11-up/down counter, when the word length is six bits. It holds the column address of a location in the display RAM. Writing data to or reading data from the display RAM causes the Y-address to be automatically incremented or decremented.

Z-address counter

The Z-address counter is a 48-up counter that provides the display RAM data for the LCD drive circuit. The data stored in the Z-address register is sent to the Z-address counter as the Z start address.

For instance, when the Z start address is 32, the counter increments as follows: 32, 33, 34..., 46, 47, 0, 1, 2...30, 31, 32. Therefore, the display start line is line 32 of the display RAM.

Up/down register

The 1-bit datum stored in this register selects either up or down mode for the X- and Y-(page) address counters.

Counter select register

The 1-bit datum stored in this register selects the X-address counter or Y-(page) address counter.

• Display ON/OFF register

This 1-bit register holds the display ON/OFF state. In the OFF state, the output data from the display RAM is cleared. In the ON state, the display RAM data is displayed. The display ON/OFF state does not affect the data in the display RAM.

Z-address register

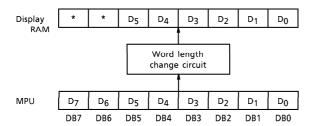
This 6-bit register holds the data which specifies the display start line. The data is loaded into the Z-address counter on the FRM signal. Using the Z-address register, vertical scrolling is possible.

Word length register

The 1-bit datum stored in this register selects the word length: eight bits per word or six bits per word.

• Word length change circuit

This circuit is controlled by the word length register. When the word length is eight bits, data is transferred eight bits at a time. When the word length is six bits, the data transfer method is as shown in Fig. 2 below.



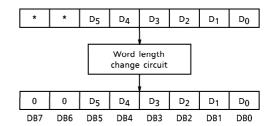
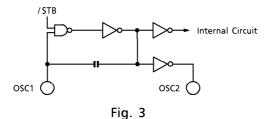


Fig. 2

*:INVALID

Oscillator

The T6B79 includes an on-chip oscillator. When using this oscillator, connect an external resistor between OSC1 and OSC2, as shown in Fig. 3. When using an external clock, connect the clock input to OSC1 and leave OSC2 open.



• Timing generation circuit

This circuit divides the signals from the oscillator and generates the display timing signals and the operating clock signal.

• Shift register

The T6B79 has two 24-bit shift registers. These two 24-bit shift registers can be combined to form a 48-bit shift register.

Latch circuit

The latch circuit latches data from the display RAM.

• Column driver circuit

The column driver circuit consists of 64 driver circuits. One of the four LCD driving levels is selected by the combination of the internal M signal and the display data transferred from the latch circuit. Details of the column driver circuit are shown in Fig. 4.

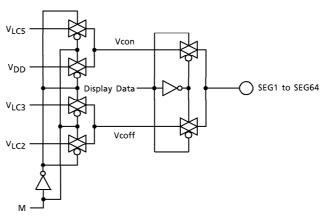
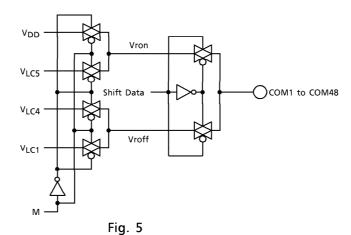


Fig. 4

Row driver circuit

The row driver circuit consists of 48 driver circuits. One of the four LCD driving levels is selected by the combination of the internal M signal and the data from the shift register. Details of the row driver circuit are shown in Fig. 5.

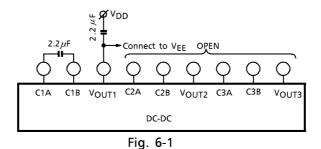


DC-DC converter

The T6B79 has an on-chip DC-DC converter. The DC-DC converter generates a $\times 2$, $\times 3$ or $\times 4$ output level. See Fig. 6.

When /STB = L, V_{OUT1} , V_{OUT2} and V_{OUT3} = 0 (V). The recommended value for the capacitor is $2.2\mu F$.

(1) Doubler (\times 2) mode



(2) Tripler (\times 3) mode

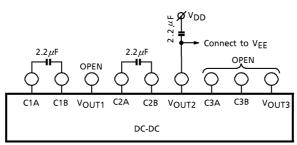


Fig. 6-2

(3) Quadruplexer (×4) mode

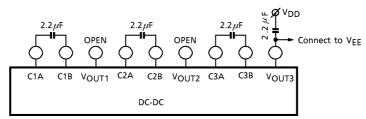


Fig. 6-3

When using an external power supply, input the voltage to VEE and do not connect the capacitors.

• Voltage divider resistors, contrast control circuit

The T6B79 has on-chip resistors which include op-amps, that divide the bias voltage, and a contrast control circuit.

The voltage bias is modified by the values of \ensuremath{R}_1 and \ensuremath{R}_2 . One of four biases can be selected.

These resistors and the contrast control circuit are shown in Fig. 7 below.

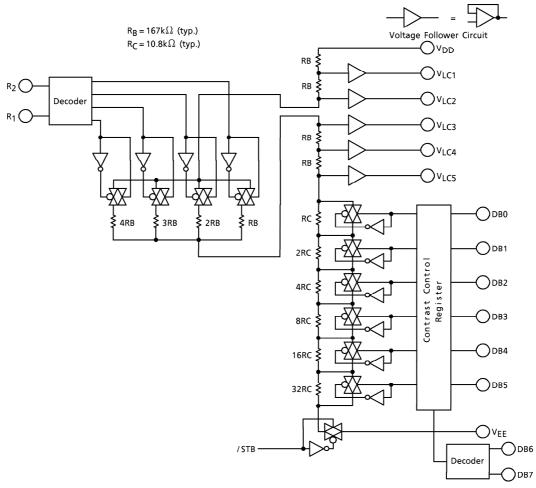


Fig. 7

Op-amp, op-amp control register

The T6B79 has five operational amplifiers which determine the LCD driving level. The power supplied by these op-amps is modified by the contents of the op-amp control register to match the LCD panel. The op-amp can also be controlled in such a way that it supplies full current on the rising edge of SEG and a reduced current otherwise.

To maintain good LCD contrast, connect a capacitor between the op-amp output and V_{DD} . The value of the capacitor should normally be in range 0.1 to 1.0μ F.

Display RAM

The display RAM consists of 48 rows × 64 columns for a total of 3072 cells. It is directly bit-mapped to the LCD. The relation between the display RAM and LCD is shown in Fig. 8.

When the word length is set to eight bits, the display RAM is arranged in eight pages and each page contains 48 words. When the word length is set to six bits, the display RAM is arranged in 11 pages and each page contains 48 words. See Fig. 9.

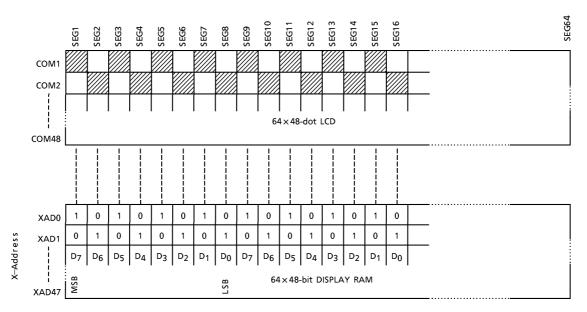
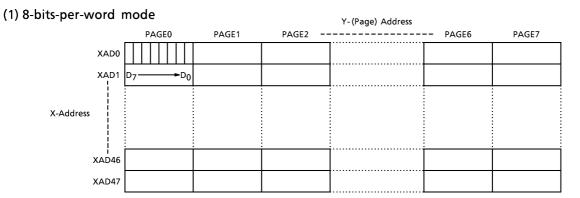


Fig. 8



(2) 6-bits-per-word mode



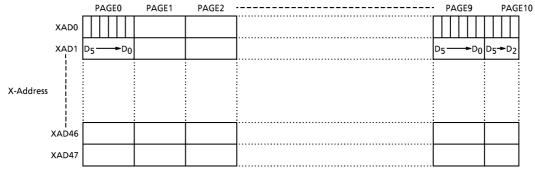


Fig. 9

COMMAND DEFINITIONS

| COMMAND NAME | D/I | /WR | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | FUNCTION |
|-----------------|-----|-----|-----|-----|-------------------|-----------|-------------|---------|----------|--------|--------------------------------------|
| DPE | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1/0 | Display ON (1) / OFF (0) |
| 86E | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1/0 | Word Length: 8 bits (1) / 6 bits (0) |
| | | | | | | | | | | | Counter Select: DB1 Y (1)/X (0) |
| UDE | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1/0 | 1/0 | Mode Select : DB0 UP (1)/ |
| | | | | | | | | | | | DOWN (0) |
| CHE | 0 | 0 | 0 | 0 | 0 | 1 | 1 | * | * | * | Test Mode Select |
| OPA1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | * | 1/0 | 1/0 | Op-Amp Power Control 1 |
| OPA2 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | * | 1/0 | 1/0 | Op-Amp Power Control 2 |
| SYE | 0 | 0 | 0 | 0 | 1 | * | Y- (Pa | ge) Add | lress (0 | to 10) | Y- (Page) Address Set |
| SZE | 0 | 0 | 0 | 1 | | Z-A | Addres | s (0 to | 47) | | Z-Address Set |
| SXE | 0 | 0 | 1 | 0 | | X-A | Addres | s (0 to | 47) | | X-Address Set |
| SCE | 0 | 0 | 1 | 1 | CO | NTRA | ST CO | NTROL | . (0 to | 63) | Contrast Set |
| STRD | 0 | 1 | В | 8/6 | D R 0 0 Y/X U/D S | | Status Read | | | | |
| DAWR | 1 | 0 | | | Write Data | | | | | | Display Data Write |
| DARD | 1 | 1 | | | | Read Data | | | | | Display Data Read |

* : INVALID

Display ON/OFF select (DPE)

| /WR | D/I | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |

Display ON (03H)
Display OFF (02H)

This command turns display ON/OFF. It does not affect the data in the display RAM. When the command "Display OFF" is selected, all column display and row display waveforms revert to the $V_{\mbox{DD}}$ level.

(Note) An L input on /RST turns display OFF.

• Word length 8 bits / 6 bits select (86E)

| /WR | D/I | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

8-bit word mode (01H)

This command sets the word length for display RAM data to either six bits or eight bits.

(Note) An L input on /RST sets the word length to eight bits per word.

• X/Y (page) counter, up/down mode select (UDE)

| /WR | D/I | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 1 |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 0 |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 1 |

X-Counter/Down Mode (04H)

X-Counter/Up Mode (05H)

Y-Counter/Down Mode (06H)

Y-Counter/Up Mode (07H)

This command selects the counter and the up/down mode. For instance, when X-counter/up mode is selected, the X-address is incremented in response to every data read and write. However, when X-Counter/up mode is selected, the address in the Y-(page) counter will not change. Hence the Y-address must be set (with the SYE command) before it can be changed.

(Note) An L input on /RST sets the Y-counter to up mode.

• Test mode select (CHE)

| /WR | D/I | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| 0 | 0 | 0 | 0 | 0 | 1 | 1 | * | * | * |

* · INVALID

This command selects the test mode. Do not use this command.

Set Y-(page) address (SYE)

| /WR | D/I | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| 0 | 0 | 0 | 0 | 1 | * | Α | Α | Α | Α |

* : INVALID

Range: 8-bit/Word: 20H to 27H (Page 0 to Page 7) 6-bit/Word: 20H to 2AH (Page 0 to Page 10)

When operating in 8-bits-per-word mode, this command selects one of the eight pages in the display RAM. (Do not try to select a page outside this range.) When operating in 6-bits-per-word mode, this command selects one of the 11 pages in the display RAM.

(Note) An L input on / RST sets the Y-address to page 0.

• Set Z-address (SZE)

| /WR | D/I | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| 0 | 0 | 0 | 1 | Α | Α | Α | Α | Α | Α |

Range: 40H to 6FH (ZAD0 to ZAD47)

This command sets the top row of the LCD screen, irrespective of the current X-address. For instance, when the Z-address is 32, the top row of the LCD screen is address 32 of the display RAM, and the bottom row of the LCD screen is address 31 of the display RAM.

(Note) An L input on / RST sets the Z-address to 0.

• Set X-address (SXE)

| /WR | D/I | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| 0 | 0 | 1 | 0 | A | A | A | A | A | Α |

Range: 80H to AFH (XAD0 to XAD47)

This command sets the X-address (in the range 0 to 47). An L input on /RST sets the X-address to page 0.

• Set contrast (SCE)

| /WR | D/I | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| 0 | 0 | 1 | 1 | Α | Α | Α | Α | Α | Α |

Range: C0H to FFH

This command sets the contrast for the LCD. The LED contrast can be set in 64 steps. The command COH selects the brightest level; the command FFH selects the darkest.

• Op-amp control 1 (OPA1)

| /WR | D/I | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-------------|
| 0 | 0 | 0 | 0 | 0 | 1 | 0 | * | Α | Α | * : INVALID |

Range: 10H to 13H (when DB2 = 0)

This command sets the power supply strength for the operational amplifier. This command selects one of four levels. The command 10H selects the lowest power supply strength and the command 13H selects the maximum power supply strength.

(Note) An L input to /RST sets the op-amp power supply strength to the lowest level.

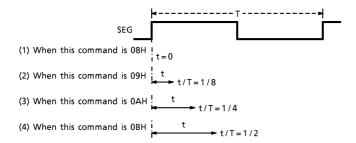
• Op-amp control 2 (OPA2)

| /WR | D/I | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 | |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-------------|
| 0 | 0 | 0 | 0 | 0 | 0 | 1 | * | Α | Α | * : INVALID |

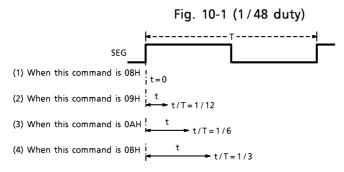
Range: 08H to 0BH (when DB2 = 0)

This command enhances the power supply strength of the operational amplifier over a short period from the rising edge of SEG. This command selects one of four levels of strength.

(Note) An L input to /RST sets t to 0 for the op-amp. See Figs. 10-1 and 10-2. It is not possible to select the combination OPA1 = 10H and OPA2 = 08H. After a Reset, set OPA1 and OPA2 according to the application.



The amplifier's strength is enhanced over the period denoted by \Leftrightarrow , starting on the rising edge of SEG.



The amplifier's strength is enhanced over the period denoted by \Leftrightarrow , starting on the rising edge of SEG.

Fig. 10-2 (1/6 or 1/32 duty)

• Status read (STRD)

| /WR | D/I | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| 1 | 0 | В | 8/6 | D | R | 0 | 0 | Y/X | U/D |

B (Busy) : When B = 1 the T6B79 is executing an internal operation and no instruction

can be accepted except STRD.

When B = 0 the T6B79 can accept an instruction.

8/6 (Word Length): When 8/6=1 the word length of the display data is eight bits per word.

When 8/6=0 the word length of the display data is six bits per word.

D (Display) : When D = 1 display is ON.

When D=0 display is OFF.

R (Reset) : When R = 1 the T6B79 is in reset state.

When R = 0 the T6B79 is in operating state.

Y/X (Counter) : When Y/X=1 the Y counter is selected.

When Y/X = 0 the X counter is selected.

U/D (Up/down) : When U/D=1 the X and Y counters are in up mode.

When U/D=0 the X and Y counters are in down mode.

Write / read display data (DAWR / DARD)

| /WR | D/I | DB7 | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| 0 | 1 | D | D | D | D | D | D | D | D |
| 1 | 1 | D | D | D | D | D | D | D | D |

DAWR: Display Data Write DARD: Display Data Read

The command DAWR writes the display data to the display RAM. The command DARD outputs the display data from the display RAM. However, when a data read is executed, the correct data does not appear on the first data reading. Therefore, ensure that the T6B79 performs a dummy data read before reading the actual data.

FUNCTION DESCRIPTION

• X-address counter and Y-(page) address counter

Fig. 11 shows a sample operation involving the X-address counter.

After Reset is executed, the X-address (XAD) becomes 0, then X-counter/up mode is selected.

Next, the X-address is set to 46 using the SXE command.

After data has been written or read, the X-address is automatically incremented by 1.

After X-counter/down mode has been selected and data has been written or read, the X-address is automatically decremented by 1.

When the X-counter is selected, the Y-counter is not incremented or decremented.

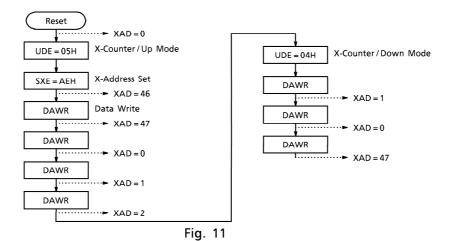


Fig. 12 shows a sample operation involving the Y-address counter in 8-bit word length mode. After Reset is executed, the Y-(page) address (Page) becomes 0, then Y-(page) counter/up mode and 8-bit word length mode are selected. After data has been written or read, the Y-(page) address counter is automatically incremented by 1.

After Y-(page) counter/down mode has been selected and data has been written or read, the Y-(page) address is automatically decremented by 1.

When the Y-(page) counter is selected, the X-counter is not incremented or decremented.

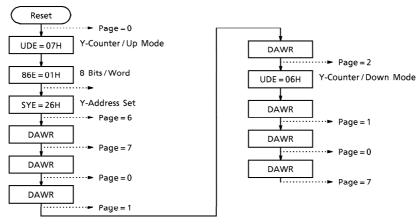


Fig. 12

When operating in 6-bit word length mode, the Y-(page) address counter can count up to 10. If Page = 10 in up mode, after data has been written or read, the Y-(page) address (Page) becomes 0.

If Page = 0 in down mode, after data has been written or read, the Y-(page) address (Page) becomes 10.

Data read

When reading data, there are some cases when dummy data must be read. This is because when the data read command is invoked, the data pointed to by the address counter is transferred to the output register; the contents of the output register are then transferred by the next data read command.

Therefore when reading data straight after power-on or straight after an address-setting command, such as SYE or SXE, a dummy data read must be performed. See Fig. 13.

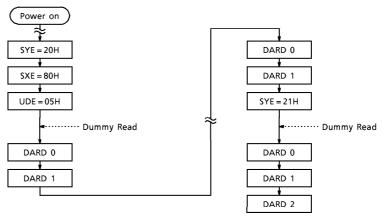


Fig. 13

Reset function

When / RST = L, the reset function is executed and the following settings are made.

- (1) Display OFF
- (2) Word length 8 bits/word
- (3) Counter mode Y-counter/up mode
- (4) Y-(page) address
 Page = 0

 (5) X-address
 XAD = 0

 (6) Z-address
 ZAD = 0

 (7) Op-amp1 (OPA1)
 min

(8) Op-amp2 (OPA2)

Standby function

When /STB = L, the T6B79 is in standby state. The internal oscillator is stopped, power consumption is reduced, and the power supply level for the LCD (V_{LC1} to V_{LC5}) becomes V_{DD} .

Busy flag

When the T6B79 is executing an internal operation (other than the STRD command), the busy flag is set to logical H. The state of the busy flag is output in response to the STRD command. While the busy flag is H, no instruction can be accepted (except the STRD command). The busy state period (T) is as follows.

 $2/f_{OSC} \le T \le 4/f_{OSC}$ [seconds] fosc : Frequency of OSC1

Oscillation frequency

The frequency select pins (FS1 and FS2) are used to set the relation between the oscillation frequency (f_{OSC}) and the frequency of the internal M signal (f_{M}), as shown in the table below.

| R_f (k Ω) | f _{OSC} (kHz) | f _M (Hz) | FS1 | FS2 |
|---------------------|------------------------|---------------------|-----|-----|
| 1200 | 26.88 | 35 | 0 | 0 |
| 570 | 53.76 | 35 | 1 | 0 |
| 130 | 215.00 | 35 | 0 | 1 |
| 61 | 430.10 | 35 | 1 | 1 |

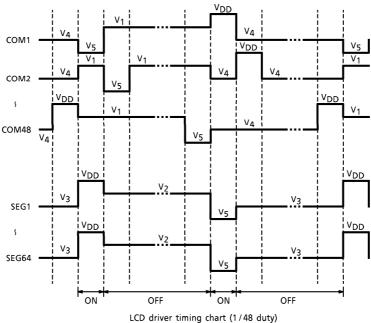
(Note) The resistance values are typical values ($V_{DD} = 5.0V$). The oscillation frequency depends on how the device is mounted. It is necessary to adjust the oscillation frequency to a target value.

Duty select

The table below shows the relation between the values on the DS1 and DS2 pins and the duty cycle.

| DS1 | DS2 | DUTY |
|-----|-----|--------|
| 0 | 0 | 1 / 16 |
| 1 | 0 | 1/32 |
| 0 | 1 | 1 / 48 |
| 1 | 1 | 1 / 48 |

LCD DRIVER WAVEFORM



ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

| ITEM | SYMBOL | RATING | UNIT |
|-----------------------|---|---|----------|
| Supply Voltage (1) | V _{DD} (Note 1) | -0.3 to 7.0 | ٧ |
| Supply Voltage (2) | V _{LC1} , 2, 3, 4, 5 V _{EE} (Note 3) | V _{DD} – 18.0 to V _{DD} + 0.3 | V |
| Input Voltage | V _{IN} (Note 1, 2) | -0.3 to V _{DD} + 0.3 | ٧ |
| Operating Temperature | T _{opr} | -20 to 75 | °C |
| Storage Temperature | T _{stg} | - 55 to 125 | °C |

(Note 1) Referenced to $V_{SS} = 0V$ (Note 2) Applies to all data bus pins and input pins except V_{EE} , V_{LC1} , V_{LC2} , V_{LC3} , V_{LC4}

and V_{LC5} . (Note 3) Ensure that the following condition is always maintained. $\mathsf{V}_{DD}\!\!\geq\!\mathsf{V}_{LC1}\!\!\geq\!\mathsf{V}_{LC2}\!\!\geq\!\mathsf{V}_{LC3}\!\!\geq\!\mathsf{V}_{LC4}\!\!\geq\!\mathsf{V}_{LC5}\!\!\geq\!\mathsf{V}_{EE}$

ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

TEST CONDITIONS (1) (Unless otherwise noted, $V_{SS} = 0V$, $V_{DD} = 3.0V \pm 10\%$, $V_{LC5} = 0V$, $T_{a} = -20$ to 75° C)

| ITEM | | SYM- BOL | TEST CIR- CUIT | TEST CONDITIONS | MIN | TYP. | MAX | UNIT | PIN NAME |
|----------------------------------|------------------------------------|-------------------------------------|----------------------|---|---------------------------|--------|--------------------------|---------------|---|
| Operating Sup | ply (1) | V_{DD} | | _ | 2.7 | _ | 3.3 | V | V_{DD} |
| Operating Sup | ply (2) | V _{LC5} V _{EE} | | _ | V _{DD} - 16.0 | _ | V _{DD} - 4.0 | > | V _{EE} , V _{LC5} |
| Innut Valtaga | H Level | V_{IH} | _ | _ | 0.8 V _{DD} | _ | V_{DD} | V | R ₁ , R ₂ , FS1, FS2, DS1, DS2, |
| Input Voltage | L Level | V _{IL} | | _ | 0 | | 0.2 V _{DD} | ٧ | DB0~DB7, D/I, /WR, /CE, /RST, /STB |
| Output Voltage | H Level | v _{OH} | | I _{OH} = -400μA | V _{DD} - 0.2 | | V_{DD} | > | D / I, / WR, / CE, DB0~DB7, / RST, |
| Voitage | L Level | V_{OL} | | $I_{OL} = 400 \mu A$ | 0 | _ | 0.2 | ٧ | / STB |
| Column Driver Resistance | Column Driver Output Resistance | | _ | $V_{DD} - V_{LC5} = 11.0V$ Load current = $\pm 100 \mu A$ | _ | | 7.5 | kΩ | SEG1 to SEG64 |
| Row Driver Ou Resistance | tput | Rrow | | VDD – VLC5 = 11.0V Load current = $\pm 100 \mu A$ | _ | | 1.5 | $\mathbf{k}Ω$ | COM1 to COM48 |
| Input Leakage | | ΙΙL | | V _{IN} = V _{DD} to GND | - 1 | 1 | 1 | μΑ | R ₁ , R ₂ , D/I, /WR, /CE, DB0~DB7, /STB, /RST, FS1, FS2, DS1, DS2 |
| Operating Free | - | fosc | | _ | 20 | _ | 500 | kHz | OSC1 |
| External Clock | Freq. | f _{ex} | _ | _ | 20 | _ | 500 | kHz | OSC1 |
| External Clock | | f_{duty} | _ | _ | 45 | 50 | 55 | % | OSC1 |
| External Clock Rise/Fall Time | | t _r /t _f | ı | _ | | | 50 | ns | OSC1 |
| Current Consumption (1) | | I _{DD1} | _ | (Note 1) | | 270 | 300 | μ A | V_{DD} |
| Current Consumption (2) | | I _{DD2} | l | (Note 2) | _ | 300 | 350 | μ A | V_{DD} |
| Current Consumption (3) I | | I _{DDSTB} | | (Note 3) | - 1 | _ | 1 | μ A | V_{DD} |
| Output Voltage (Quadruplexer | | VO3 | 3 | (Note 4) | - 6.40 | - 7.00 | _ | V | V _{OUT3} |

(Note 1) $V_{DD} = 3.0 \pm 10\%$, $V_{EE} = V_{OUT}$ (from DC-DC converter), no data access

 $\begin{array}{lll} R_f = 47k\Omega, \text{ no load, } 1/8 \text{ bias, FS1, } 2 = \text{H, op-amp strength at minimum level} \\ \text{(Note 2)} & V_{DD} = 3.0 \pm 10\%, V_{EE} = V_{OUT} \text{ (from DC-DC converter), data access cycle } f_{/CE} = 1\text{MHz,} \\ R_f = 47k\Omega, \text{ no load, } 1/8 \text{ bias, FS1, } 2 = \text{H, op-amp strength at minimum level} \\ \end{array}$

(Note 3) $V_{DD} = 3.0 \pm 10\%$, $V_{DD} - V_{EE} = 16.0V$, /STB = L (Note 4) $V_{DD} = 3.0V$, $I_{Load} = 500 \mu A$, $V_{EE} = -9.0V$ (external power supply) $CnA - CnB = 2.2 \mu F$, $V_{DD} - V_{OUT3} = 2.2 \mu F$, $R_f = 47 k \Omega$, $T_a = 25^{\circ} C$

DC CHARACTERISTICS

TEST CONDITIONS (2) (Unless otherwise noted, $V_{SS} = 0V$, $V_{DD} = 5.0V \pm 10\%$, $V_{LC5} = 0V$, $T_{a} = -20$ to 75°C)

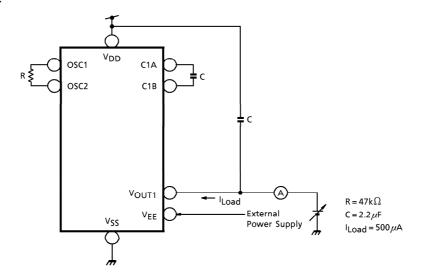
| | | _ | | | | | | |
|----------------------------------|--|--|--|--|---|--|---|---|
| M | SYM- BOL | CIR- | TEST CONDITIONS | MIN | TYP. | MAX | UNIT | PIN NAME |
| pply (1) | V_{DD} | _ | _ | 4.5 | _ | 5.5 | V | V_{DD} |
| ipply (2) | V _{LC5} V _{EE} | _ | _ | V _{DD} - 16.0 | _ | V _{DD} - 4.0 | ٧ | V _{EE} , V _{LC5} |
| H Level | V _{IH} | _ | _ | 0.7 V _{DD} | _ | V_{DD} | ٧ | R ₁ , R ₂ , FS1, FS2, DS1, DS2, |
| L Level | V _{IL} | _ | _ | 0 | _ | 0.3 VDD | ٧ | DB0 to DB7, D/I,/WR,/CE, /RST,/STB |
| H Level | Voн | _ | I _{OH} = -400μA | V _{DD} - 0.2 | _ | V_{DD} | ٧ | D/I, /WR, /CE, DB0 to DB7, |
| L Level | VOL | | I _{OL} = 400μA | 0 | _ | 0.2 | ٧ | /RST,/STB |
| er Output | Rcol | _ | $V_{DD} - V_{LC5} = 11.0V$ Load current = $\pm 100 \mu A$ | 1 | _ | 7.5 | $\mathbf{k}Ω$ | SEG1 to SEG64 |
| Row Driver Output Resistance | | _ | $V_{DD} - V_{LC5} = 11.0V$ Load current = $\pm 100 \mu A$ | _ | _ | 1.5 | kΩ | COM1 to COM48 |
| e | ΊιL | _ | V _{IN} = V _{DD} to GND | – 1 | - | 1 | μΑ | R ₁ , R ₂ , D/I, /WR, /CE, DB0 to DB7, /STB, /RST, FS1, FS2, DS1, DS2 |
| eq. | fosc | _ | _ | 20 | _ | 500 | kHz | OSC1 |
| k Freq. | f _{ex} | | _ | 20 | _ | 500 | kHz | OSC1 |
| k Duty | $f_{ m duty}$ | - | _ | 45 | 50 | 55 | % | OSC1 |
| k Rise/Fall | t _r /t _f | _ | _ | | _ | 50 | ns | OSC1 |
| umption (1) | I _{DD1} | _ | (Note 1) | | 470 | 650 | μΑ | V_{DD} |
| | | | (Note 2) | _ | 500 | 700 | μΑ | V_{DD} |
| | | _ | (Note 3) | - 1 | _ | 1 | μ A | V_{DD} |
| Output Voltage (Doubler Mode) | | 1 | (Note 4) | - 4.25 | - 4.50 | | > | V _{OUT1} |
| ige e) | VO2 | 2 | (Note 5) | - 8.50 | - 9.00 | | ٧ | V _{OUT2} |
| | H Level L Level L Level C Level L Leve | IM BOL Ipply (1) VDD Ipply (2) VLC5 VEE H Level VIH L Level VOH L Level VOL Per Output Rcol Output Rrow IL Eq. fosc k Freq. fex k Duty fduty k Rise/Fall tr/tf umption (1) IDD1 umption (2) IDD2 umption (3) IDDSTB upge upge VO2 | M BOL CIR-CUIT Ipply (1) VDD — Ipply (2) VLC5 VEE — H Level VIH — L Level VOH — L Level VOL — er Output Rcol — Output Rrow — IL Freq. fex — k Duty fduty — k Rise / Fall tr / tf — umption (1) IDD1 — umption (2) IDD2 — umption (3) IDDSTB — Ipple VO2 2 | BOL CIR-CUIT TEST CONDITIONS Teply (1) VDD — — — | M BOL CIR-CUIT TEST CONDITIONS MIN Apply (1) VDD — — 4.5 Apply (2) VLC5 VEE — — 4.5 H Level VIH — — 0.7 L Level VIL — — 0 H Level VOH — IOH = -400 μA VDD -0.2 L Level VOL — IOL = 400 μA 0 Per Output Rcol — VDD - VLC5 = 11.0V Load current = ±100 μA Dutput Rrow — VDD - VLC5 = 11.0V Load current = ±100 μA Per IIL — VIN = VDD to GND — 1 Peq. fosc — — 20 R Freq. fex — — 20 R Freq. fex — — 20 R Duty fduty — — 45 R Rise / Fall tr / tf — — — 45 Umption (1) IDD1 — (Note 1) — 1 Umption (2) IDD2 — (Note 2) — 1 Umption (3) IDDSTB — (Note 4) — 4.25 Umption (4) IDD — (Note 4) — 4.25 Umption (90 — 10 — 10 — 10 — 10 — 10 — 10 — 10 — | M BOL CIR- TEST CONDITIONS MIN TYP. Ipply (1) VDD — — 4.5 — Ipply (2) VLC5 — — VDD — It Level VIH — — 0.7 VDD — It Level VOH — IOH = -400 μA VDD — It Level VOH — IOH = -400 μA 0 — It Level VOL — IOH = 400 μA 0 — It Level VOL — IOH = 1.00 μA 0 — It In In It In In It In In It In It In It In It In It In In It In In It In In In It In In It In In It In In It In | M BOL CIR-CUIT TEST CONDITIONS MIN TYP. MAX Max | M BOL CIR- TEST CONDITIONS MIN TYP. MAX UNIT UNIT Max UNIT UNIT |

- (Note 1) $V_{DD} = 5.0 \pm 10\%$, $V_{EE} = V_{OUT}$ (from DC-DC converter), no data access $R_f = 47k\Omega$, no load, 1/8 bias, FS1, 2 = H, op-amp strength at minimum level
- (Note 2) $V_{DD} = 5.0 \pm 10\%$, $V_{EE} = V_{OUT}$ (from DC-DC converter), data access cycle f/CE = 1MHz, R_f = 47k Ω , no load, 1/8 bias, FS1, 2 = H, op-amp strength at minimum level (Note 3) V_{DD} = 5.0 \pm 10%, V_{DD} – V_{EE} = 16.0V, /STB = L
- (Note 4) $V_{DD} = 5.0V$, $I_{Load} = 500 \mu A$, $V_{EE} = -5.0V$ (external power supply) CnA CnB = $2.2 \mu F$, $V_{DD} V_{OUT1} = 2.2 \mu F$, $R_f = 47 k \Omega$, Ta = $25 ^{\circ} C$ (Note 5) $V_{DD} = 5.0V$, $I_{Load} = 500 \mu A$, $V_{EE} = -10.0V$ (external power supply)
- CnA CnB = 2.2μ F, V_{DD} V_{OUT2} = 2.2μ F, R_f = $47k\Omega$, Ta = 25° C

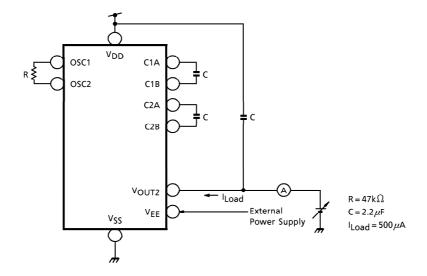
TOSHIBA

TEST CIRCUIT

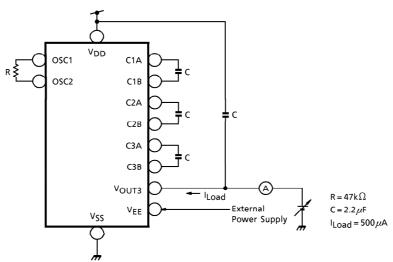
1. Doubler mode



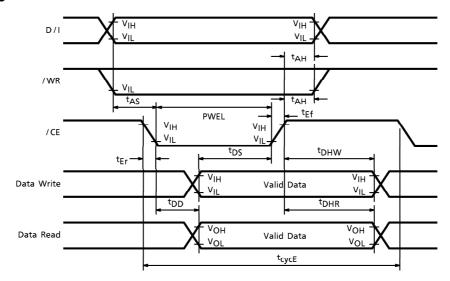
2. Tripler mode



3. Quadruplexer mode



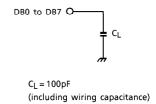
AC CHARACTERISTICS



TEST CONDITIONS (1) (VSS = 0V, VDD = 3.0V \pm 10%, VLC5 = 0V, Ta = -20 to 75°C)

| ITEM | SYMBOL | MIN | MAX | UNIT |
|-----------------------|-----------------------------------|------|-----|------|
| Enable Cycle Time | t _{cycE} | 1000 | _ | ns |
| Enable Pulse Width | PWEL | 450 | - | ns |
| Enable Rise/Fall Time | t _{Er} , t _{Ef} | _ | 25 | ns |
| Address Set-up Time | t _{AS} | 40 | _ | ns |
| Address Hold Time | t _{AH} | 10 | _ | ns |
| Data Set-up Time | t _{DS} | 280 | | ns |
| Data Hold Time | tDHW | 10 | | ns |
| Data Delay Time | t _{DD} (Note) | _ | 300 | ns |
| Data Hold Time | t _{DHR} (Note) | 20 | | ns |

LOAD CIRCUIT



TEST CONDITIONS (2) $(V_{SS} = 0V, V_{DD} = 5.0V \pm 10\%, V_{LC5} = 0V, Ta = -20 to 75^{\circ}C)$

| ITEM | SYMBOL | MIN | MAX | UNIT |
|-----------------------|-----------------------------------|-----|-----|------|
| Enable Cycle Time | t _{cycE} | 500 | _ | ns |
| Enable Pulse Width | PWEL | 220 | _ | ns |
| Enable Rise/Fall Time | t _{Er} , t _{Ef} | | 20 | ns |
| Address Set-up Time | t _{AS} | 40 | | ns |
| Address Hold Time | t _{AH} | 0 | l | ns |
| Data Set-up Time | t _{DS} | 60 | 1 | ns |
| Data Hold Time | tDHW | 10 | l | ns |
| Data Delay Time | t _{DD} (Note) | | 120 | ns |
| Data Hold Time | t _{DHR} (Note) | 20 | | ns |

(Note) With load circuit connected

APPLICATION CIRCUIT

- Oscillation frequency is at a minimum.
- LCD drive bias is 1/8.
- DC-DC converter in doubler mode is used.

